

# Harvatek Surface Mount LEDs Data Sheet HT-F107TW

Official Product	HT-F107TW	Your Part No.		Data Sheet No.
		*****	HT-F107TW	
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#### **DISCLAIMER**

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- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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#### **Product Specification**

	Specification	Material	Quantity
lv	Cool White: 1900~2850 mcd		
	@20mA/ Ts= 25°C; Tolerance: + 10%		
Chromaticity	Refer to page 8		
Coordinates	@20mA/ Ta= 25 <sup>o</sup> C		
	Tolerance: ± 0.01		
Vf	Cool White:2.8~3.5 V (0.1V/Bin)		
	@20mA/ Ts= 25°C; Tolerance: + 0.05V		
Resin	Yellow	Silicone resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified
O.11	•	•	•

#### Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, lv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

#### ATTENTION: Electricstatic Discharge (ESD) protection

The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built

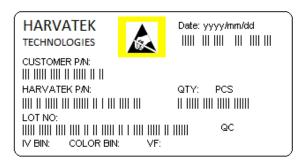
with AllnGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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#### Label Spec.



#### Harvatek P/N

# H T - F 1 0 7 TW - XXXX



Series Name	Emitting Color	Custom code
HT-F107:	TW:	XXXX
3.8x1.0x0.6mm	White@20mA	Customer product code

#### Lot No.

1 2	3	4	5	6	7	8	9	10
E 1	Α	1	Α	2	2	L	1	2
Code 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number		Special code	
Internal Tracing Code	2010-A 2011-B 2012-C 2013-D	1:Jan. 2:Feb.  A:Oct. B:Nov. C:Dec.	1:A 2:B 3:C  26:Z 27:7 28:8 29:9 30:3 31:4	01-	~ZZ		000~ZZZ	

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# ■ Luminous Intensity (Iv) Bin:

	3 ( )			
Bin	Luminous Intensity Range (mcd)			
	Minimum	Maximum		
Z52	1900	2010		
Z61	2010	2125		
Z62	2125	2250		
<b>Z</b> 71	2250	2385		
<b>Z</b> 72	2385	2530		
Z81	2530	2685		
Z82	2685	2850		

@20mA / Ta=25° C, Tolerance: <u>+</u> 10%

# ■ Forward Voltage (V<sub>F</sub>) Bin:

Bin	Range
H1	2.8 – 2.9V
H2	2.9 – 3.0V
Н3	3.0 – 3.1V
H4	3.1 – 3.2V
J1	3.2 – 3.3V
J2	3.3 – 3.4V
J3	3.4 – 3.5V

@20mA / Ta=25° C, Tolerance: <u>+</u> 0.05 V

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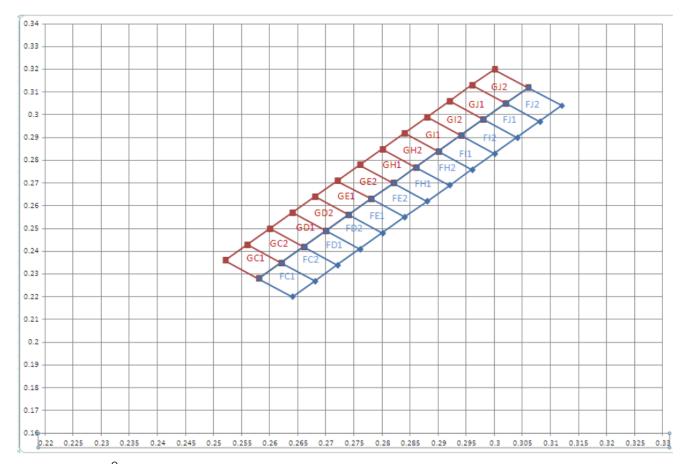


# ■XY Chromaticity Bin:

	x	у		x	у		x	у		x	у
	0.258	0.228		0.264	0.22		0.282	0.27		0.288	0.262
	0.252	0.236	1	0.258	0.228		0.276	0.278	1	0.282	0.27
GC1	0.256	0.243	FC1	0.262	0.235	GH1	0.28	0.285	FH1	0.286	0.277
	0.262	0.235		0.268	0.227		0.286	0.277		0.292	0.269
	0.258	0.228		0.264	0.22		0.282	0.27		0.288	0.262
	0.262	0.235		0.268	0.227		0.286	0.277		0.292	0.269
	0.256	0.243		0.262	0.235		0.28	0.285		0.286	0.277
GC2	0.26	0.25	FC2	0.266	0.242	GH2	0.284	0.292	FH2	0.29	0.284
	0.266	0.242		0.272	0.234		0.29	0.284		0.296	0.276
	0.262	0.235		0.268	0.227		0.286	0.277		0.292	0.269
	0.266	0.242		0.272	0.234		0.29	0.284		0.296	0.276
	0.26	0.25		0.266	0.242		0.284	0.292		0.29	0.284
GD1	0.264	0.257	FD1	0.27	0.249	GI1	0.288	0.299	FI1	0.294	0.291
	0.27	0.249		0.276	0.241		0.294	0.291		0.3	0.283
	0.266	0.242	1	0.272	0.234		0.29	0.284	1	0.296	0.276
	0.27	0.249		0.276	0.241		0.294	0.291		0.3	0.283
	0.264	0.257		0.27	0.249		0.288	0.299		0.294	0.291
GD2	0.268	0.264	FD2	0.274	0.256	GI2	0.292	0.306	FI2	0.298	0.298
	0.274	0.256		0.28	0.248		0.298	0.298		0.304	0.29
	0.27	0.249		0.276	0.241		0.294	0.291		0.3	0.283
	0.274	0.256		0.28	0.248		0.298	0.298		0.304	0.29
	0.268	0.264		0.274	0.256		0.292	0.306		0.298	0.298
GE1	0.272	0.271	FE1	0.278	0.263	GJ1	0.296	0.313	FJ1	0.302	0.305
	0.278	0.263		0.284	0.255		0.302	0.305		0.308	0.297
	0.274	0.256		0.28	0.248		0.298	0.298		0.304	0.29
	0.278	0.263		0.284	0.255		0.302	0.305		0.308	0.297
	0.272	0.271		0.278	0.263		0.296	0.313		0.302	0.305
GE2	0.276	0.278	FE2	0.282	0.27	GJ2	0.3	0.32	FJ2	0.306	0.312
	0.282	0.27		0.288	0.262		0.306	0.312		0.312	0.304
	0.278	0.263		0.284	0.255		0.302	0.305		0.308	0.297

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@20mA / Ta=25° C, Tolerance: <u>+</u> 0.01

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#### **Product Characteristics**

#### **Electro-Optical Characteristics**

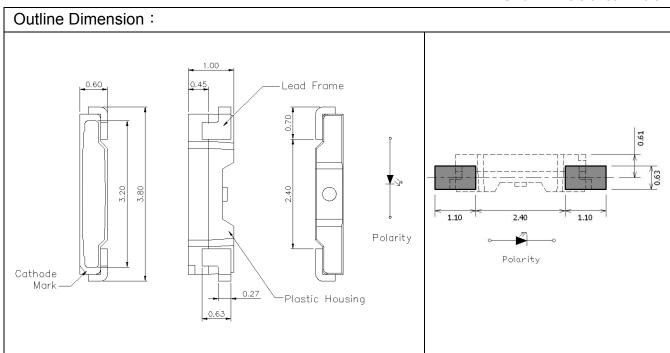
(I<sub>F</sub> @ 20mA, T<sub>a</sub> 25 °C)

Droduct No.	Lighting	Material	$V_{F}$	(V)	λ (ι	nm)	I <sup>*</sup> <sub>V</sub> (mcd)	Viewing Angle
Product No.	Color	Material	Тур.	max	λD	λ <sub>P</sub>	Тур.	2θ 2/1
HT-F107TW	White	InGaN	2.8	3.5	X=0.285 Y=0.27	1	2350	120

<sup>\*</sup> Per NIST standards

## Package Outline Dimension

Unit: mm Tolerance: +/-0.01



#### Absolute Maximum Ratings

(T<sub>a</sub> 25 °C)

Series	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> (mA)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
HT-F107TW	105	30	100	5	-40~+85	-40~+100

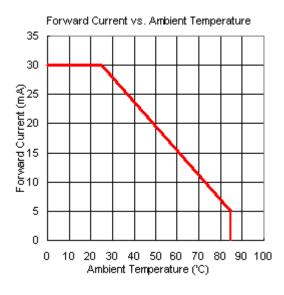
<sup>\*</sup> Condition for  $I_{FP}$  is pulse of 1/10 duty and 0.1msec width

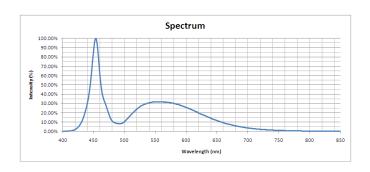
<sup>\*\*</sup>Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

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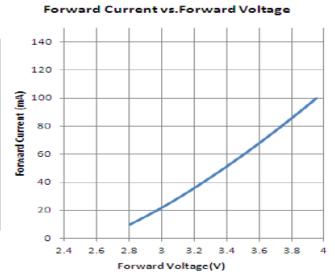


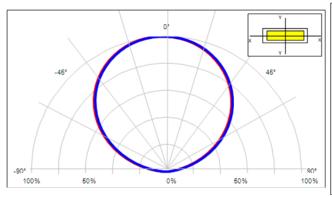
#### **Characteristics Curves**

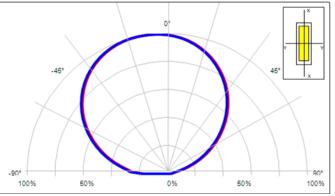




# Temp vs Luminous 100.00% 90.00% 25 45 65 85 105 Temperture



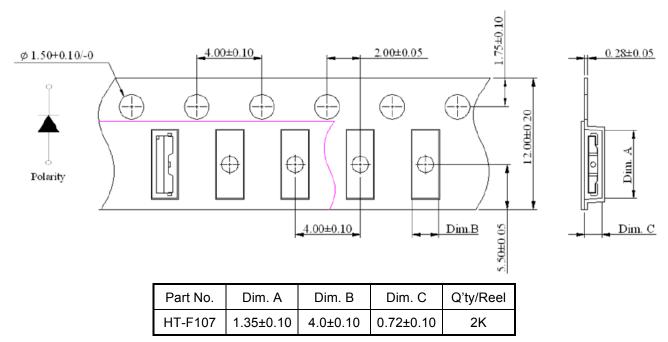




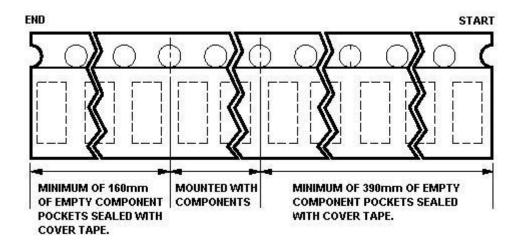
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# Packaging Tape, Reel, and Packing Model Tape Dimension



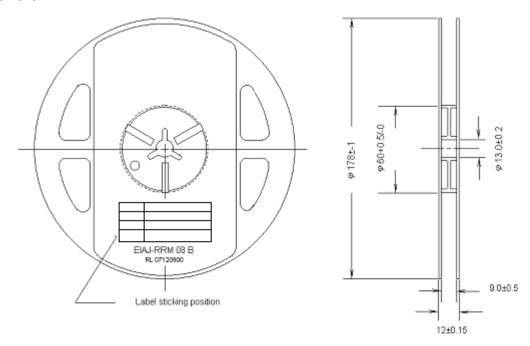
Unit: mm



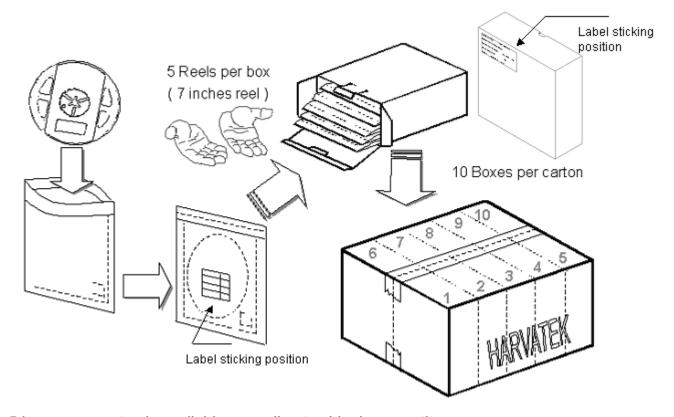
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#### **Reel Dimension**



### **Packing Model**



5 boxes per carton is available according to shipping quantity.

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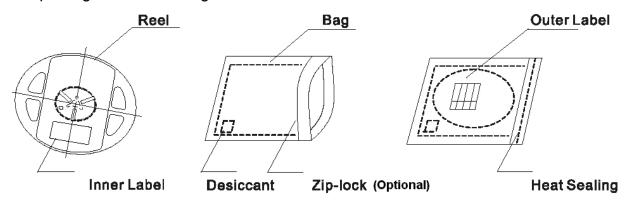


#### **Dry Pack**

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:



#### Storage

It's recommended to store the products in the following conditions:

Humidity: 60 %RH Max.

Temperature: 5 °C ~30 °C (41°F~86 °F)

- 1 Shelf life in sealed bag: 12 month at<40 <sup>o</sup>C and <90%RH. (Base on aluminum laminated moisture barrier bag.)
- 2 After the bag is opened, devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing must be:
  - 2.1 Mounted within 72 hours at factory conditions of  $\leq$  30  $^{\circ}$ C /60% RH, or
  - 2.2 Stored at  $\leq$  20% RH with zip-lock sealed.

#### **Baking**

It's recommended to bake before soldering when the pack is unsealed after 15 days. The conditions are as followings:

- a) 60  $\pm 3^{\circ}$ Cx(12~24hrs) and < 5% RH, taped reel type
- b) 100±3°Cx(45min~1hr), bulk type
- c) 130±3°Cx(15~30min), bulk type

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#### **Cautions of Pick and Place**

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

#### **PRECAUTIONS**

- 1. Avoid absorbing moisture at any time during transportation or storage.
- 2. Anti-Static process is needed especially when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
- 4. Any application should refer to the specifications of absolute maximum ratings.
- 5. Avoid any direct contact with the viewing area.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

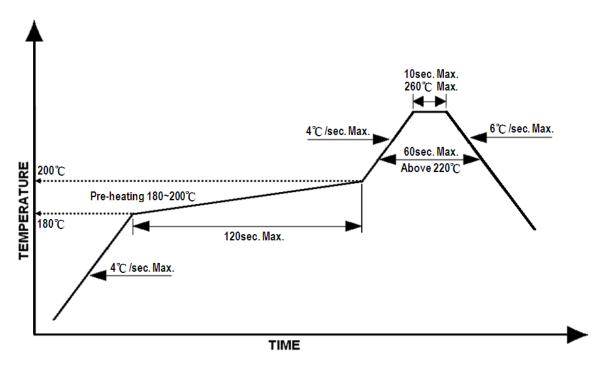
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#### **Re-flow Soldering**

- Recommend tin glue specifications:
   Melting temperature: 178~192 °C
- ◆ Never take next process until the component is cooled down to room temperature after re-flow.
- ◆ The recommended re-flow soldering profile (measuring on the surface of the LED resin) is following:

#### Lead-free Solder



#### Rework

- ♦ Customer must finish rework within 5 sec. under 260 °C.
- ◆ The head of iron cannot touch copper foil.
- ◆ Twin-head type is preferred.

#### Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature×Time: <50 °C×30sec, or <30 °C×3min

Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

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# **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release F107TW		V1.0	10-19-2013

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